

Single P-channel MOSFET

ELM14443AA-N

General description

ELM14443AA-N uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance.

Features

- $V_{ds} = -40V$
- $I_d = -6.5A$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 42m\Omega$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 63m\Omega$ ($V_{gs} = -4.5V$)

Maximum absolute ratings

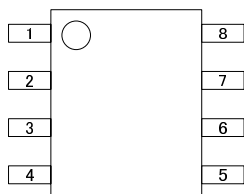
Parameter	Symbol	Limit	Unit	Note	
Drain-source voltage	V_{ds}	-40	V		
Gate-source voltage	V_{gs}	± 20	V		
Continuous drain current	I_d	$T_a = 25^\circ C$	-6.5	A	1
		$T_a = 70^\circ C$	-5.0		
Pulsed drain current	I_{dm}	-20	A	2	
Power dissipation	P_d	$T_a = 25^\circ C$	3.1	W	1
		$T_a = 70^\circ C$	2.0		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	$^\circ C$		

Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R\theta_{ja}$	24	40	$^\circ C/W$	1
Maximum junction-to-ambient	Steady-state		54	75	$^\circ C/W$	
Maximum junction-to-lead	Steady-state	$R\theta_{jl}$	21	30	$^\circ C/W$	3

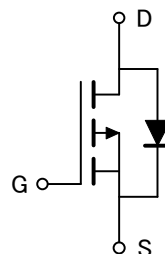
Pin configuration

SOP-8 (TOP VIEW)



Pin No.	Pin name
1	SOURCE
2	SOURCE
3	SOURCE
4	GATE
5	DRAIN
6	DRAIN
7	DRAIN
8	DRAIN

Circuit



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Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BV _{dss}	I _d =-250 μA, V _{gs} =0V	-40			V
Zero gate voltage drain current	I _{dss}	V _{ds} =-32V			-1	μA
		V _{gs} =0V		T _j =55°C	-5	
Gate-body leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±20V			±100	nA
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , I _d =-250 μA	-1.0	-1.9	-3.0	V
On state drain current	I _{d(on)}	V _{gs} =-10V, V _{ds} =-5V	-20			A
Static drain-source on-resistance	R _{ds(on)}	V _{gs} =-10V		33.3	42.0	mΩ
		I _d =-6A	T _j =125°C	54.0	68.0	
		V _{gs} =-4.5V, I _d =-5A		48.0	63.0	mΩ
Forward transconductance	G _{fs}	V _{ds} =-5V, I _d =-6A		14		S
Diode forward voltage	V _{sd}	I _s =-1A, V _{gs} =0V		-0.75	-1.00	V
Max. body-diode continuous current	I _s				-6	A
DYNAMIC PARAMETERS						
Input capacitance	C _{iss}			657		pF
Output capacitance	C _{oss}	V _{gs} =0V, V _{ds} =-20V, f=1MHz		143		pF
Reverse transfer capacitance	C _{rss}			63		pF
Gate resistance	R _g	V _{gs} =0V, V _{ds} =0V, f=1MHz		6.5		Ω
SWITCHING PARAMETERS						
Total gate charge (10V)	Q _g	V _{gs} =-10V, V _{ds} =-20V, I _d =-6A		14.2		nC
Total gate charge (4.5V)	Q _g			7.1		nC
Gate-source charge	Q _{gs}			2.2		nC
Gate-drain charge	Q _{gd}			4.1		nC
Turn-on delay time	t _{d(on)}			7.7		ns
Turn-on rise time	t _r	V _{gs} =-10V, V _{ds} =-20V		8.0		ns
Turn-off delay time	t _{d(off)}	R _l =3.7 Ω, R _{gen} =3 Ω		26.5		ns
Turn-off fall time	t _f			11.5		ns
Body diode reverse recovery time	t _{rr}	I _f =-6A, dI/dt=100A/μs		21.9		ns
Body diode reverse recovery charge	Q _{rr}	I _f =-6A, dI/dt=100A/μs		14.9		nC

NOTE :

1. The value of R_{θja} is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with T_a=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_a=25°C. The SOA curve provides a single pulse rating.

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Typical electrical and thermal characteristics

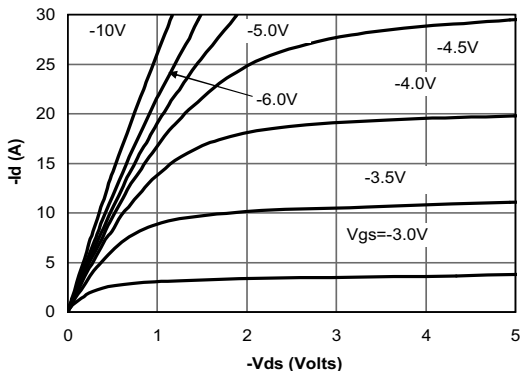


Fig 1: On-Region Characteristics

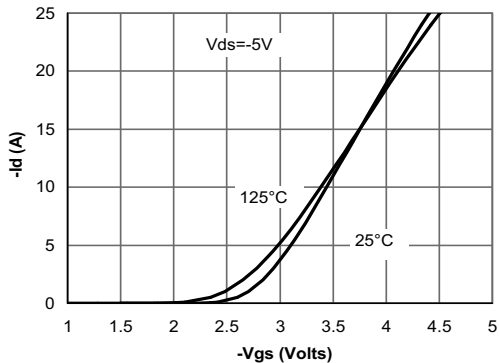


Figure 2: Transfer Characteristics

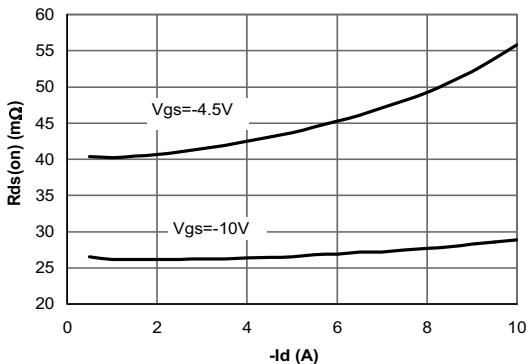


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

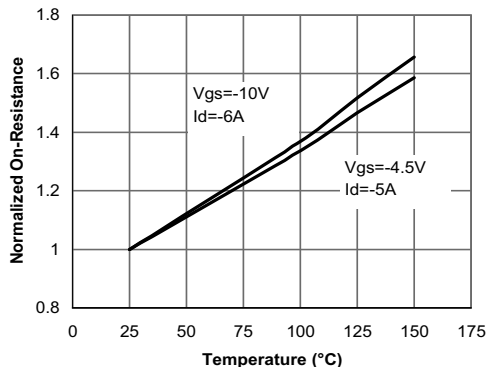


Figure 4: On-Resistance vs. Junction Temperature

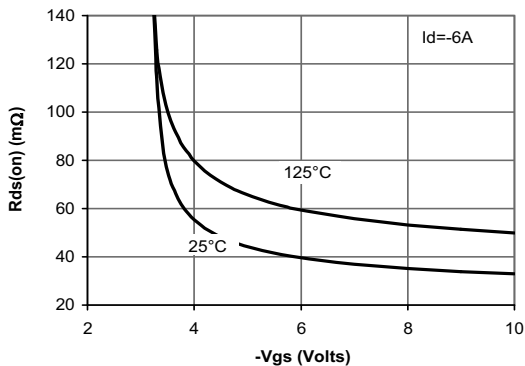


Figure 5: On-Resistance vs. Gate-Source Voltage

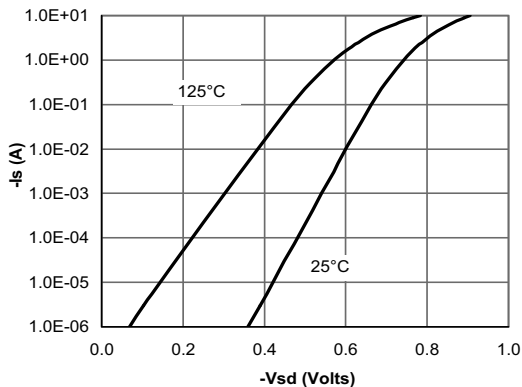


Figure 6: Body-Diode Characteristics

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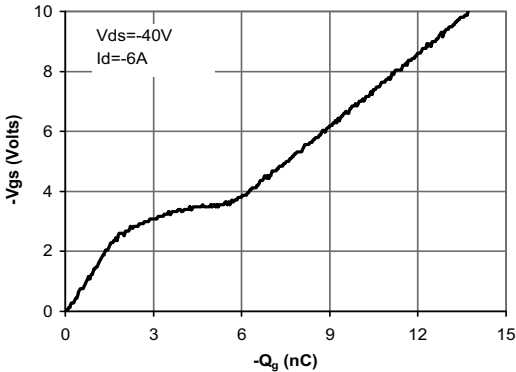


Figure 7: Gate-Charge Characteristics

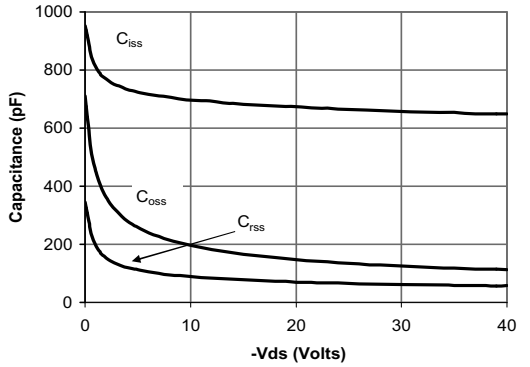


Figure 8: Capacitance Characteristics

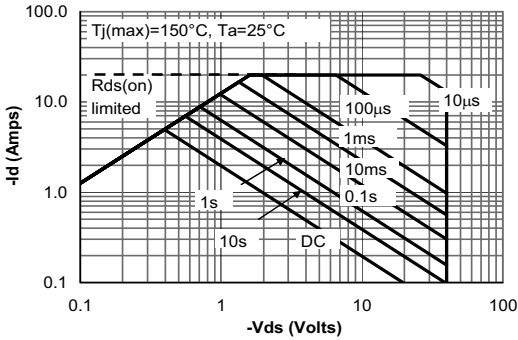


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

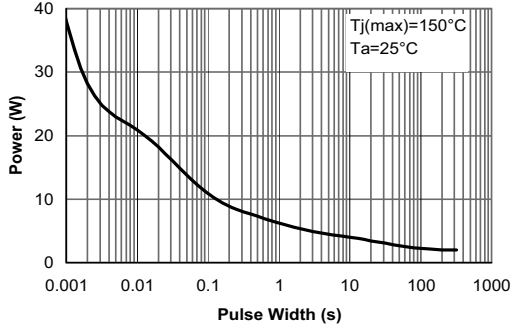


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

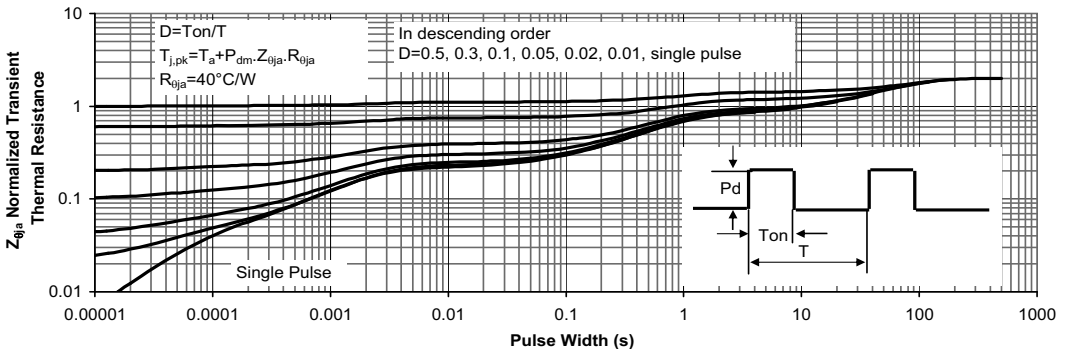


Figure 11: Normalized Maximum Transient Thermal Impedance